



# Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

**Adobe Reader version 7.0.5 is required to complete this declaration.**

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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## Supplier Information

<b>Company Name *</b> SEMTECH CORPORATION	Company Unique ID 00-847-9941	Unique ID Authority DUNS	<b>Response Date *</b> 2013-07-22	Response Document ID				
<b>Contact Name *</b> ROYA READER	Title - Contact QA Customer Service Specialis	<b>Phone - Contact *</b> (805) 389-2742	<b>Email - Contact *</b> rreader@semtech.com	Duplicate Contact -> Authorized Representative				
<b>Authorized Representative *</b> ROYA READER	Title - Representative QA Customer Service Specialis	<b>Phone - Representative *</b> (805) 389-2742	<b>Email - Representative *</b> rreader@semtech.com	Supplier Comments or URL for Additional Information				
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	EClamp2522P.TCT	USB Upstream Port Filter and			China	4.2273	mg	Each
Alternate Recommendation				Alternate Item Comments				

## Manufacturing Process Information

Terminal Plating / Grid Array Material <b>Nickel/Palladium/Gold (Ni/Pd/Au)</b>	Terminal Base Alloy <b>CU Alloy</b>	J-STD-020 MSL Rating <b>1</b>	Peak Process Body Temperature <b>260 C</b>	Max Time at Peak Temperature <b>30 seconds</b>	Number of Reflow Cycles <b>3</b>
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Comments

Save the fields in this form to a file

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Clear all of the fields on this form

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Lock Supplier Fields

## RoHS Material Composition Declaration

Declaration Type \*

Detailed

**RoHS Directive 2002/95/EC** **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.

**RoHS Declaration \*** 1 - Item(s) does not contain RoHS restricted substances per the definition above

**Supplier Acceptance \*** Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name	Homogeneous Material	Weight	Unit of Measure	Level	Substance Category	Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
											-	+	
+I -I Die	+M -M Doped Silicon	0.1264	mg	+C -C Supplier		+S -S Si	7440-21-3		0.1264	mg			29,892
+I -I Lead frame	+M -M C7025	1.496313	mg	+C -C Supplier		+S -S Cu	7440-50-8		1.435	mg			339,46
						+S -S Si	7440-21-3		0.0108	mg			2,566
				+C -C B	Nickel (external applic	+S -S Nickel	7440-02-0		0.0479	mg			11,327
				+C -C Supplier		+S -S Mg	7439-95-4		0.0026	mg			619
	+M -M Ni/Pd/Au plating	0.038367	mg	+C -C B		+S -S Nickel	7440-02-0		0.0346	mg			8,184
				+C -C Supplier	middle plating	+S -S Pd	7440-05-3		0.0031	mg			744
				+C -C Supplier	outer plating	+S -S Au	7440-57-5		0.0006	mg			148
+I -I Bonding wire	+M -M Gold	0.0451	mg	+C -C Supplier		+S -S Au	7440-57-5		0.0451	mg			10,666
+I -I Molding compound	+M -M EME-G770HCD	2.46221	mg	+C -C Supplier		+S -S Silica fused	60676-86-0		2.3022	mg			544,61
						+S -S Epoxy resin	Proprietary		0.0739	mg			17,474
						+S -S Phenol resin	Proprietary		0.0739	mg			17,474
						+S -S C	1333-86-4		0.0123	mg			2,912
+I -I Die attached epoxy	+M -M QMI519	0.058841	mg	+C -C Supplier		+S -S Ag	7440-22-4		0.0471	mg			11,136
						+S -S palladium compound	Proprietary		0.0001	mg			21
						+S -S 2,6-Di-tert-butyl-p-creso	128-37-0		0.000003	mg			1
						+S -S Hydroquinone	123-31-9		0.000000	mg			0.01
						+S -S Acrylate	Proprietary		0.0093	mg			2,206
						+S -S Bismaleimide resin	Proprietary		0.0018	mg			418
						+S -S Polymer of polybutadie	Proprietary		0.0006	mg			139